1. Part No. Expression:

<u>W7F900-RN-10</u>

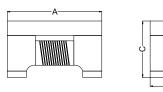
(a) (b)(c) (d) (e)(f) (g)

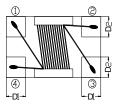
- (a) Series Code
- (b) Dimension Code
- (c) Material Code

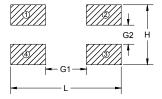
(d) Impedance Code

- (e) Packaging Code
- (f) Current Rating Code
- (g) Internal Controlled N umber

2. Configuration & Dimensions:





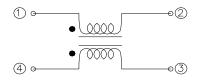


Recommended PCB layout

Unit: mm

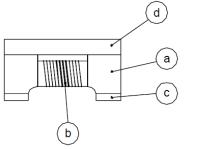
А	В	С	D1	D2	L	G1	G2	Н
4.5±0.2	3.2±0.2	2.8±0.2	1.0±0.1	1.2±0.1	4.8 Ref.	2.5 Ref.	0.7 Ref.	3.8 Ref.

3. Schematic:



NOTE: Specifications subject to change without notice. Please check our website for latest information.

4. Material List:



- (a) Core
- (b) Wire
- (c) Terminal
- (d) Upper Plate

5. General Specification:

(a)Operating Temp. : -40°C to +125°C(Including self - temperature rise)

(b) Storage Temp. : -40°C to +125°C (on board)

- (c) Humidity Range: 85 ± 2% RH
- (d) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity : 60% RH

6. Electrical Characteristics:

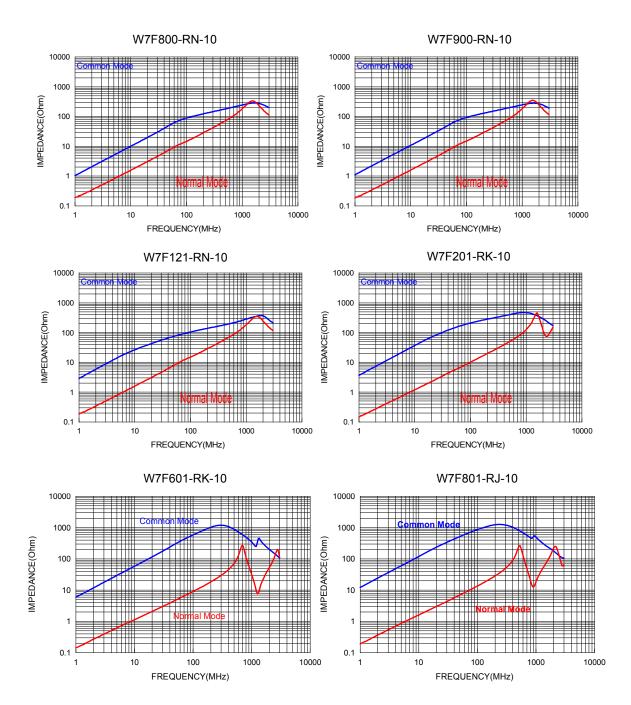
Part Number	Common Mode Impedance (Ω) ±25%	Test Frequency (MHz)	DCR (Ω) Max.	Rated Current (mA) Max.	Rated Volt (Vdc) Max.	Withstand Volt (Vdc) Max.	IR (Ω) Min.
W7F800-RN-10	80	100	0.05	3000	50	125	10M
W7F900-RN-10	90	100	0.05	3000	50	125	10M
W7F121-RN-10	120	100	0.05	3000	50	125	10M
W7F201-RK-10	200	100	0.10	1500	50	125	10M
W7F601-RK-10	600	100	0.24	1500	50	125	10M
W7F801-RJ-10	800	100	0.24	1000	50	125	10M

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7. Characteristics Curves:



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8. Soldering:

Mildly activated rosin fluxes are preferred. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

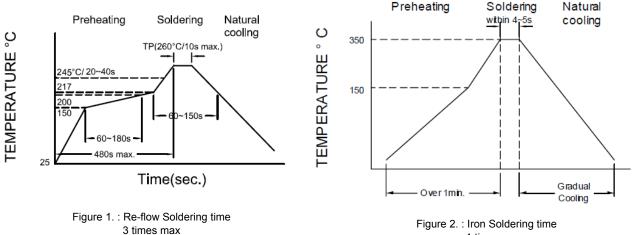
8-1 Solder Re-flow

Recommended temperature profiles for re-flow soldering in Figure 1.

8-2 Soldering Iron (Figure 2)

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 sec.



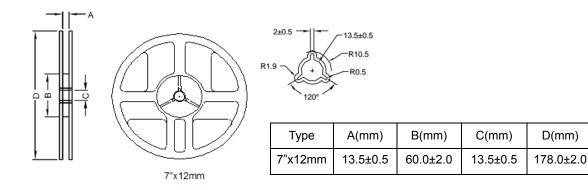
1 times max

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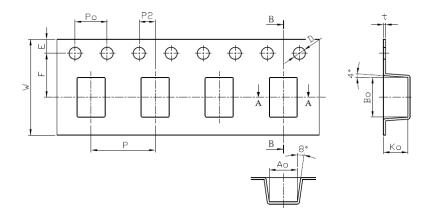
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9. Packaging Information:

9-1 Reel Dimension



9-2 Tape Dimension



Size	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)
Size	8.00±0.10	4.00±0.10	2.00±0.05	4.90±0.10	3.60±0.10	3.00±0.10
W7F	D(mm)	E(mm)	F(mm)	W(mm)	t(mm)	
VV/1	1.05+0.10/-0.00	1.75±0.10	5.50±0.05	12.00±0.10	0.26±0.05	

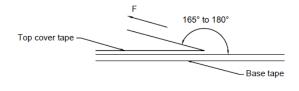
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9-3 Packaging Quantity

Chip Size	W7F		
Chip/Reel	500		
Inner Box	2,000		
Middle Box	10,000		
Carton	20,000		

9-4 Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C) Room Humidity (%)		Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice:

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.

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- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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